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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JIALIN ZOU	06/05/2020
TINGTING GENG	06/08/2020
LE YAN	06/08/2020
QINGHAI ZENG	06/08/2020
YALIN LIU	06/06/2020

RECEIVING PARTY DATA

Name:	HUAWEI TECHNOLOGIES CO., LTD.	
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State/Country:	CHINA	
Postal Code:	518129	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16895745

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Address Line 4: DALLAS, TEXAS 75252

ATTORNEY DOCKET NUMBER:	HW 85518761US04
NAME OF SUBMITTER:	GUDDI KANOJIA
SIGNATURE:	/Guddi Kanojia/
DATE SIGNED:	06/08/2020

Total Attachments: 5

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WHEREAS, I/We, the undersigned inventor(s) (or one of the undersigned joint inventors), of residence as listed below, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Huawei Technologies Co., Ltd. ("Assignee"), a corporation organized and existing under the laws of China, having a principal place of business at Huawei Administration Building, Bantian, Longgang, Shenzhen, Guangdong, 518129 China, is desirous of acquiring my/our entire right, title and interest in the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I/we will assign, and hereby assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive right, title and interest in and to the invention in the United States and every other country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisional, reissues, reexaminations, National Phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every other country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and I/we do hereby authorize and request the Commissioner for Patents to issue U.S. patents for said invention, or patent resulting therefrom, insofar as my/our interest is concerned, to the Assignee agreeably with the terms of this assignment document.

I/we also hereby agree to sell and to assign, and sell and assign to Assignee, its successors and assigns, my/our international rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of any International Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I/we hereby further agree that I/we will communicate to Assignee, or its successors, assigns, and legal representative, any facts known to me/us respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all documents required for divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid such Assignee, its successors, assigns and nominees to obtain and enforce proper patent protection for said

Huawei Technologies Co., Ltd. Patent Reference No. HW 85518761US04

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invention in all countries.

I/we hereby authorize Assignee to modify this Assignment at a later date for the purpose of adding information to better identify the invention, such as the application serial number, and filing date of a patent application filed thereon.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	Methods for Mobility Latency Reduction in a Hierarchical NR Architecture		
	Appl. No.	F	iling Date:
Signature of Inventor:	Sinde		
Inventor Name:	Jialin Zou	Date	06/05/202
Residence (City/State):	Randolph, NJ		
Signature of Witness:	La monte		
Witness Name:	DANHONG WU	Date	6/5/2020
Residence (City/State):	Randelph NI		
Signature of Inventor:			
Inventor Name:	Tingting Geng	Date	(m) no mathatha i mai na m
Residence (City/State):	Shenzhen, CN	· · · · · · · · · · · · · · · · · · ·	
Signature of Witness:			
Witness Name:		Date	
Residence (City/State):			
Signature of Inventor:		•••••••••••••••••••••••••••••••••••••••	
Inventor Name:	Le Yan	Date	
Residence (City/State):	Shenzhen, CN		
Signature of Witness:			
Witness Name:		Date	** \$15.04
Residence (City/State):			

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invention in all countries.

I/we hereby authorize Assignee to modify this Assignment at a later date for the purpose of adding information to better identify the invention, such as the application serial number, and filing date of a patent application filed thereon.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

Title of Invention	Methods for Mobility Latency Reduction in a Hierarchical NR Architecture	
	Appl. No.	Filing Date:
Signature of Inventor:		
Inventor Name:	Jialin Zou	Date
Residence (City/State):	Randolph, NJ	
Signature of Witness:		
Witness Name:		Date
Residence (City/State):		4
Signature of Inventor:	Tina tina Gena	
Inventor Name:	Ting ting Geng	Date lun V Jala
Residence (City/State):	Shenzhen, CN	Date Jun 8, 2020
	1977 P. 1974 P. 1974 Add P. 1974 College Manager of College Co	
Signature of Witness:	Yodan Nu	
Witness Name:	Yedan Wu	Date Jun 8, 2020
Residence (City/State):	Shanghai, CN	
Signature of Inventor:	Le Yan	
Inventor Name:	Le Yan	Date Tun 8, 2020
Residence (City/State):	Shenzhen, CN	June June June
Signature of Witness:	Haiyan Luo	
Witness Name:	Haiyan Lao	Date Jun 8, 2020
Residence (City/State):	Shanghai CN	-

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Signature of Inventor: Inventor Name:	Dinghai Zeng Qinghai Zeng	Date Jun 8, 2020
Residence (City/State):	Shenzhen, CN	And the second s
Signature of Witness:	Lai Sun	
Witness Name:	Fei Sun.	Date Jun. 8 row
Residence (City/State):	Shawahaci (N	J. W.
	J .	A SALAMAN AND A
Signature of Inventor:		
Inventor Name:	Yalin Liu	Date
Residence (City/State):	Shenzhen, CN	
Signature of Witness:		
Witness Name:	A VANA OF HISTORY	Date
Residence (City/State):	NAMES AND ASSOCIATION OF THE PROPERTY OF THE P	

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Signature of Inventor:		
Inventor Name:	Qinghai Zeng	Date
Residence (City/State):	Shenzhen, CN	
Signature of Witness:		
Witness Name:		Date
Residence (City/State):		normania de la composição
Signature of Inventor:	Yolin Lin	
Inventor Name:	Yalin Liu	Date Jun 06, 2020
Residence (City/State):	Shenzhen, CN	G. C.
Signature of Witness:	44	
Witness Name:	44	Date Jun. 06. 2020
Residence (City/State):	Shenzhon CN	

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